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See Moyuan Cao *et al.*, pp. 3351–3359.
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See Tomonori Saito *et al.*, pp. 3360–3368.
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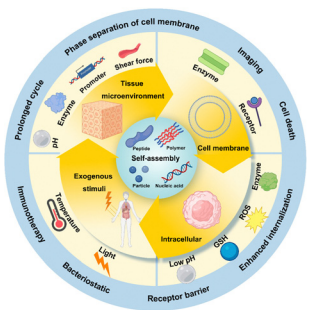
EDITORIAL

REVIEWS



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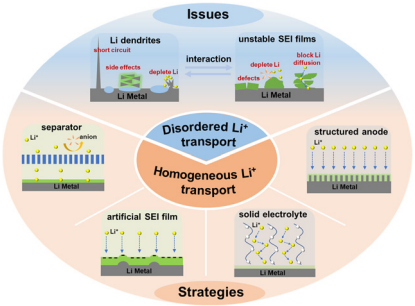

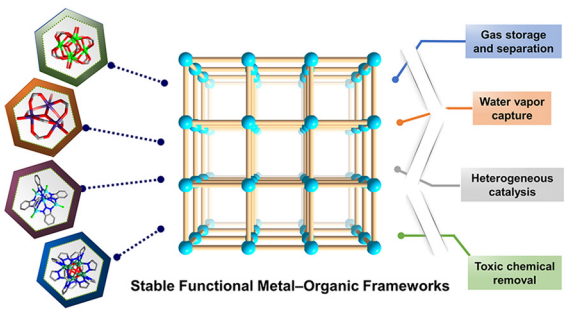

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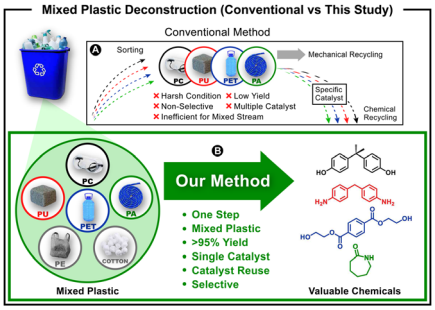

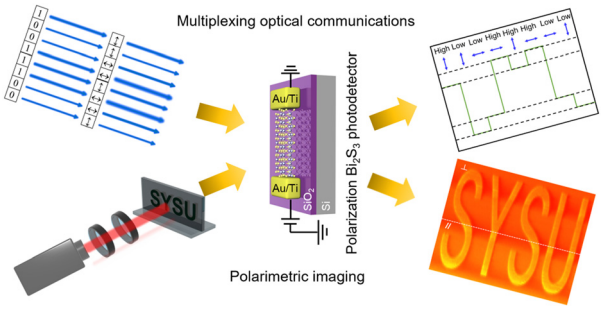

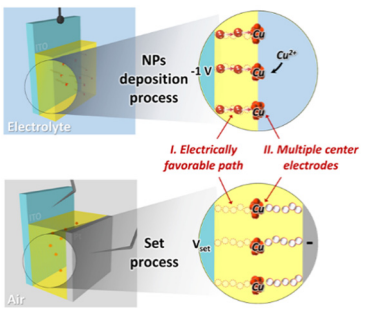

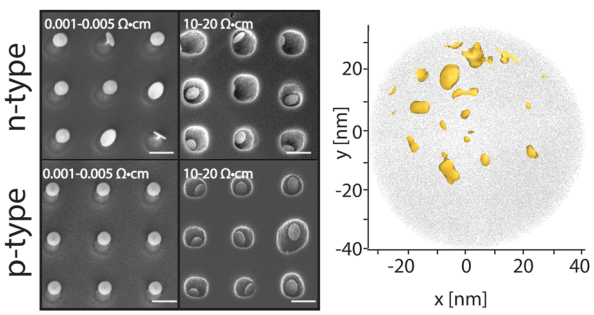

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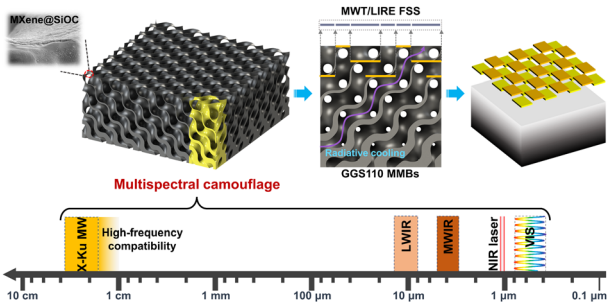

Wide-temperature-range multispectral camouflage enabled by orientation-gradient co-optimized microwave blackbody metastructure coupled with conformal MXene coating

Li Yao, Longkai Pan, Shixiang Zhou, Hongxia Liu, Hui Mei,* Yang Li, Konstantinos G. Dassios, Paolo Colombo, Laifei Cheng and Litong Zhang

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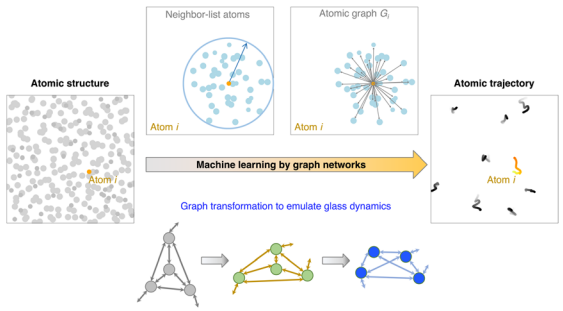

Learning molecular dynamics: predicting the dynamics of glasses by a machine learning simulator

Han Liu,* Zijie Huang, Samuel S. Schoenholz, Ekin D. Cubuk, Morten M. Smedskjaer, Yizhou Sun, Wei Wang and Mathieu Bauchy*

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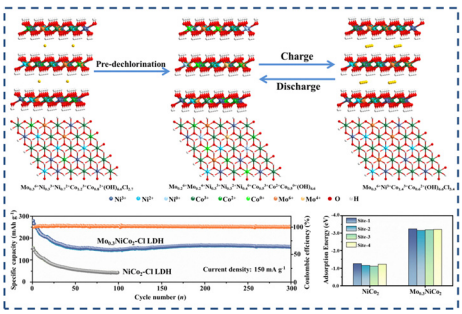

Introducing high-valence molybdenum to stimulate lattice oxygen in a NiCo LDH cathode for chloride ion batteries

Shuhan Yang, Qing Yin,* Zhihao Song, Fan Xu, Zelin Xie, Yunjia Wu, Shilin Xu, Yong-Zhi Li, Danyang Zhao, Bin Xiao, Xiaolan Xue, Jiqiu Qi, Yanwei Sui* and Jingbin Han

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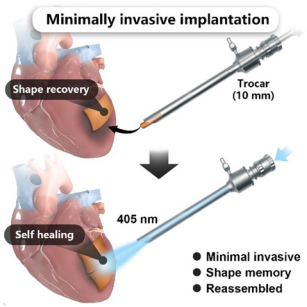

In vivo self-assembled shape-memory polyurethane for minimally invasive delivery and therapy

Shifen Li, Hua Zhang, Jieqi Xie, Zhaoyi Wang, Kai Wang, Zihe Zhai, Jie Ding, Shuqin Wang, Liyin Shen, Jun Wen, Yi-Da Tang, Huanan Wang, Yang Zhu* and Changyou Gao*

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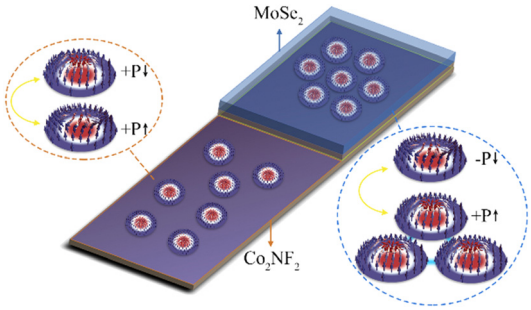

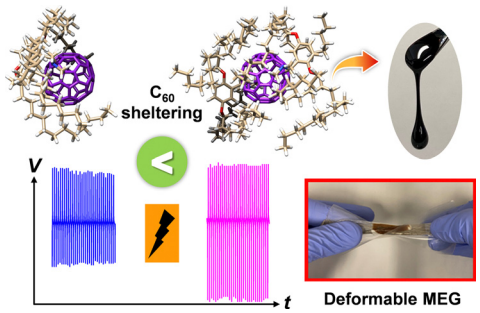

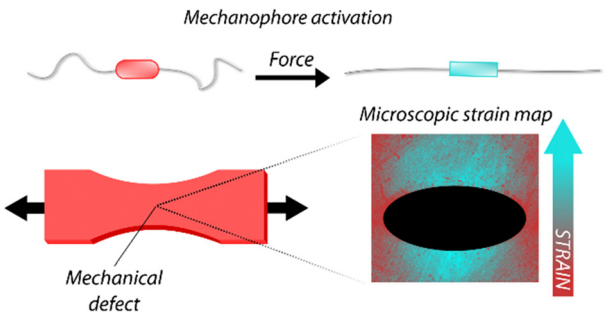

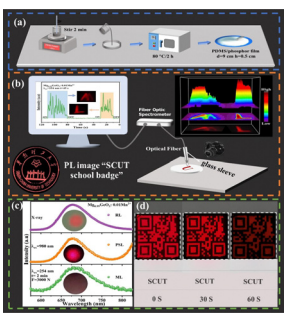

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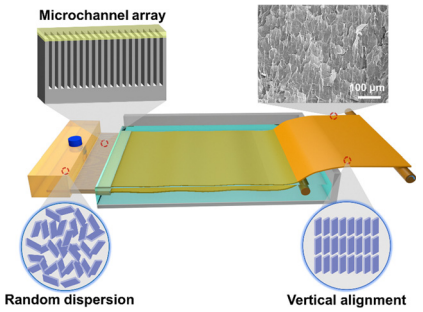

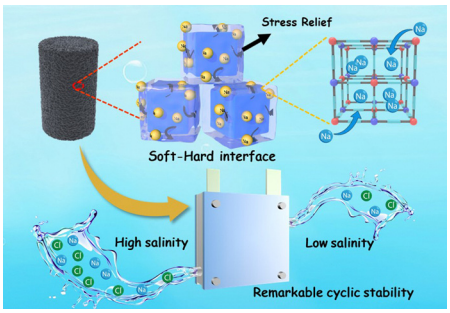

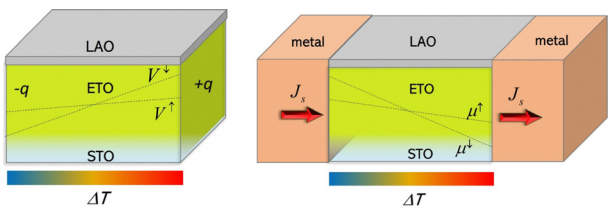

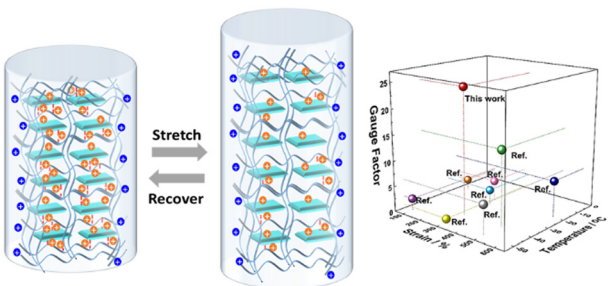

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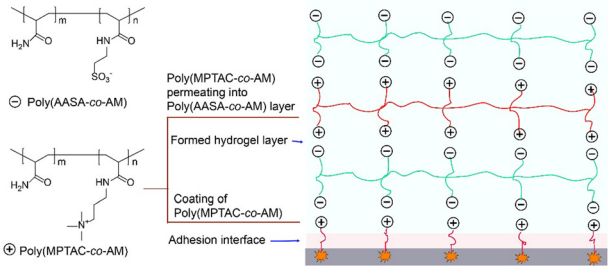
In situ molecular permeation of liquid cationic polymers into solid anionic polymer films enabling self-adaptive adhesion of hydrogel biosensors

Danqing Zhou, Jiahui Yu,* Qiuhua Zhao* and Lidong Zhang*



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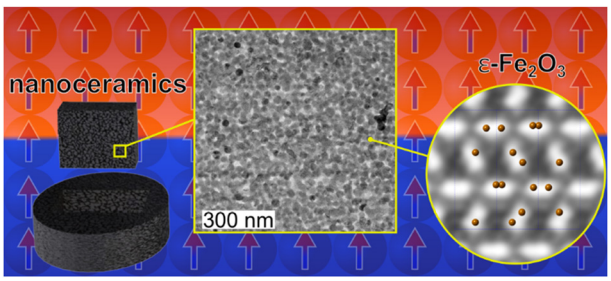
Nanoceramics of metastable ε-Fe_2O_3: effect of sintering on the magnetic properties and sub-terahertz electron resonance

Evgeny A. Gorbachev,* Liudmila N. Alyabyeva, Miroslav V. Soshnikov, Vasily A. Lebedev, Anatolii V. Morozov, Ekaterina S. Kozlyakova, Asmaa Ahmed, Artem A. Eliseev and Lev A. Trusov*



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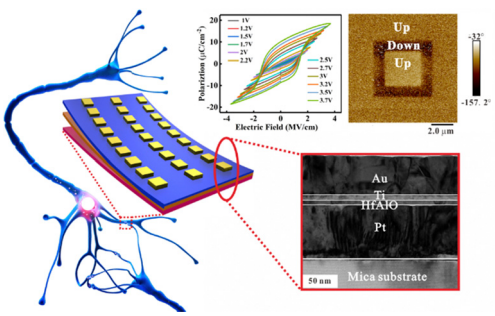
Flexible aluminum-doped hafnium oxide ferroelectric synapse devices for neuromorphic computing

Zhenhai Li, Tianyu Wang,* Jialin Meng, Hao Zhu, Qingqing Sun, David Wei Zhang and Lin Chen*



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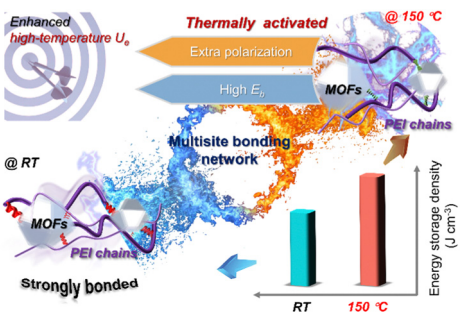
Thermally activated dynamic bonding network for enhancing high-temperature energy storage performance of PEI-based dielectrics

Jialong Li, Xiaoxu Liu,* Bingshun Huang, Dongyang Chen, Zhaoru Chen, Yanpeng Li, Yu Feng, Jinghua Yin, Haozhe Yi and Taoqi Li



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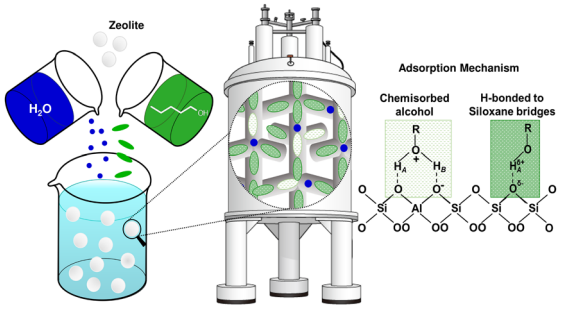

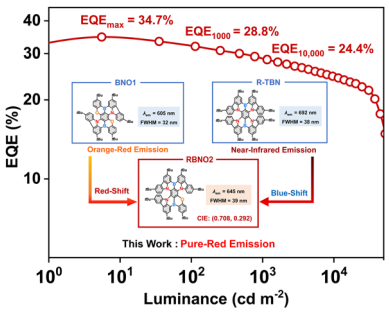

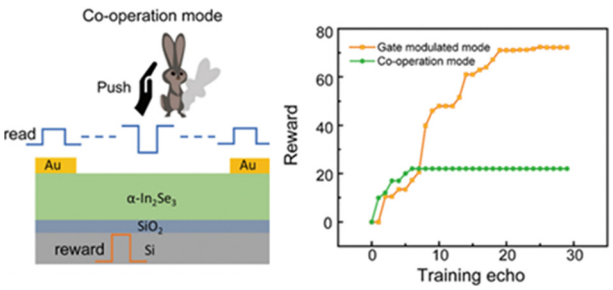

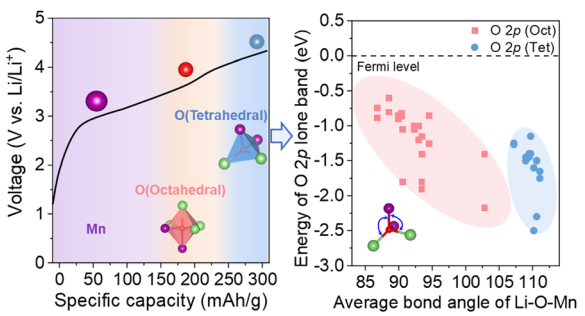

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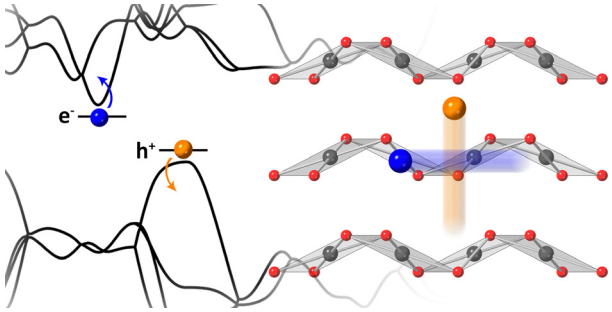

Axis dependent conduction polarity in the air-stable semiconductor, $PdSe_2$

Ryan A. Nelson, Ziling Deng, Andrew M. Ochs, Karl G. Koster, Cullen T. Irvine, Joseph P. Heremans, Wolfgang Windl and Joshua E. Goldberger*

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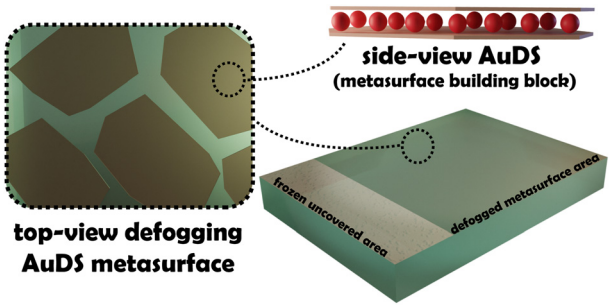

Fabricating defogging metasurfaces *via* a water-based colloidal route

Olena Khoruzhenko, Volodymyr Dudko, Sabine Rosenfeldt and Josef Breu*

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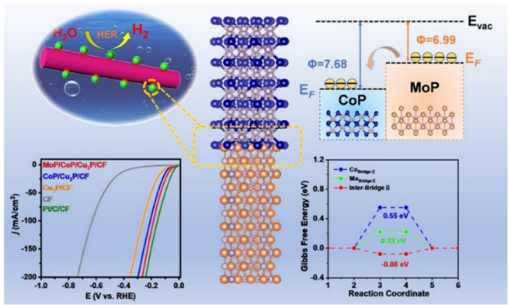

Constructing abundant interfaces by decorating MoP quantum dots on CoP nanowires to induce electronic structure modulation for enhanced hydrogen evolution reaction

Yuanyuan Chen, Tingting Sui, Chaojie Lyu, Kaili Wu, Jiwen Wu, Meifang Huang, Ju Hao, Woon-Ming Lau, Chubin Wan,* Dawei Pang* and Jinlong Zheng*

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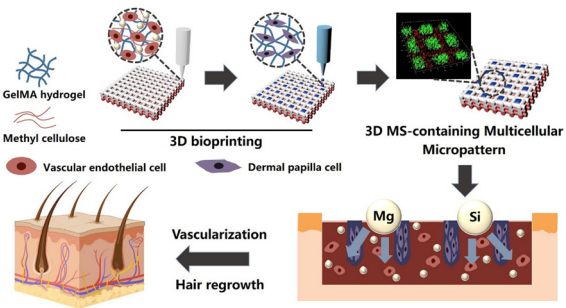

3D multicellular micropatterning biomaterials for hair regeneration and vascularization

Jingge Ma, Chen Qin, Jinfu Wu, Hui Zhuang, Lin Du, Jinfu Xu and Chengtie Wu*

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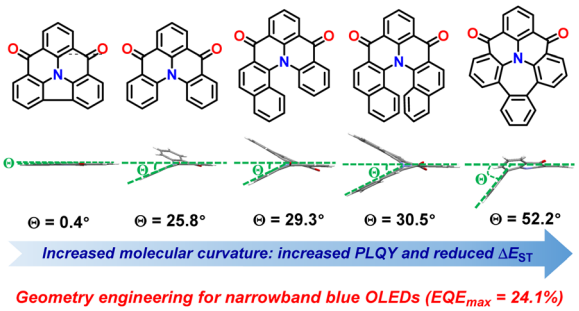

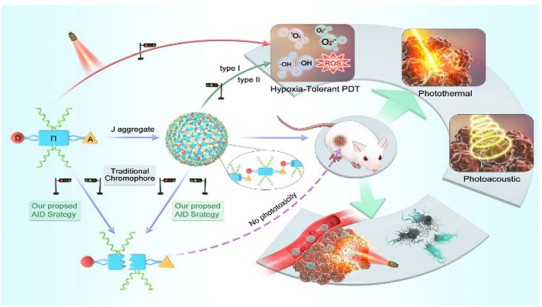

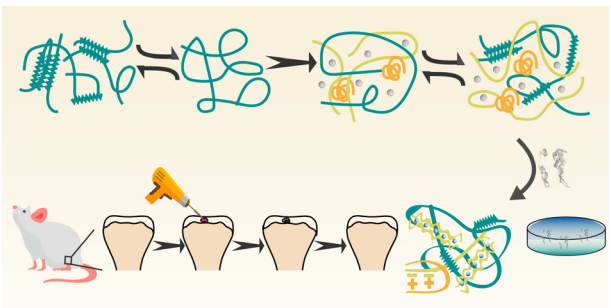

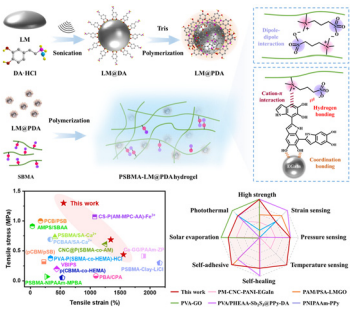

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